

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Strobel, et al.

Title: RADIATION SHIELDING OF
INTEGRATED CIRCUITS
AND MULTI-CHIP
MODULES IN CERAMIC
AND METAL PACKAGES


Prior Appl. No.: 09/456,631

Prior Appl.
Filing Date: 12/08/1999

Examiner: Unassigned

Art Unit: Unassigned

Mail Stop PATENT APPLICATION
Commissioner for Patents
PO Box 1450
Alexandria, Virginia 22313-1450

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PRELIMINARY AMENDMENT

Sir:

Prior to examination of the present Divisional Application, Applicants respectfully request that the application be amended as follows:

Amendments to the Specification begin on page 2 of this document.

Remarks/Arguments begin on page 3 of this document.

Please amend the application as follows: